## 504661429 11/29/2017

EPAS ID: PAT4708151

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
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TAKENORI OKUSA	11/02/2017

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### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15577863

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NAME OF SUBMITTER:	SHRINATH MALUR
SIGNATURE:	/Shrinath Malur/
DATE SIGNED:	11/29/2017

**Total Attachments: 1** 

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PATENT 504661429 REEL: 044246 FRAME: 0473

## ASSIGNMENT ( 譲 渡 証 )

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation a corporation organized under the laws of Japan,

located at 24-14, Nishi-Shimbashi 1-chome, Minato-ku, Tokyo 105-8717, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation its successor and assigns, all my right, title and interest, in and for the United States of America, in and to

#### **AUTOMATED ANALYZER**

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi High-Technologies Corporation

its successor, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation

Signed on the date(s) indicated aside our signatures:

**RECORDED: 11/29/2017** 

INVENTOR(S)

(発明者フルネームサイン)		(署名日)		
1)_	Yu Niiyama	Yu NIIYAMA	11/2/2017	
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PATENT REEL: 044246 FRAME: 0474

Date Signed